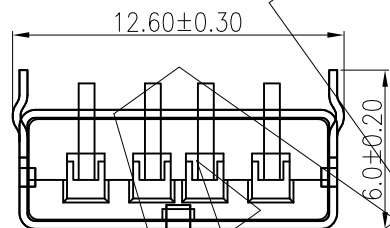
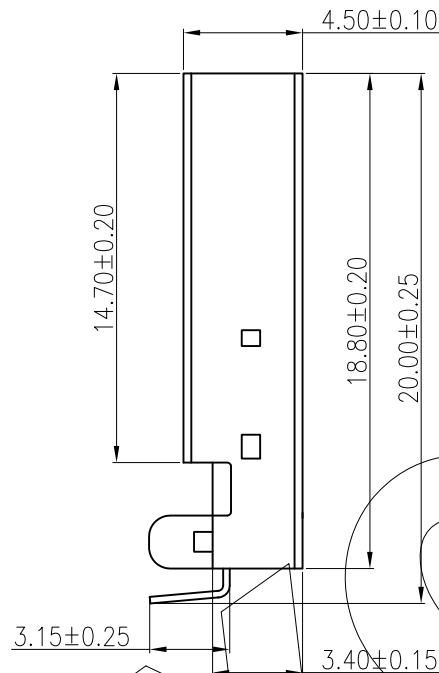
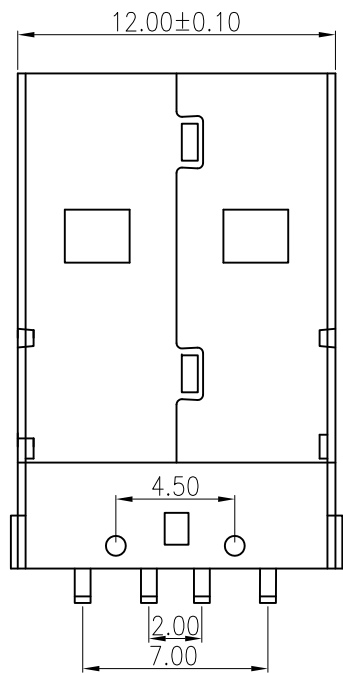
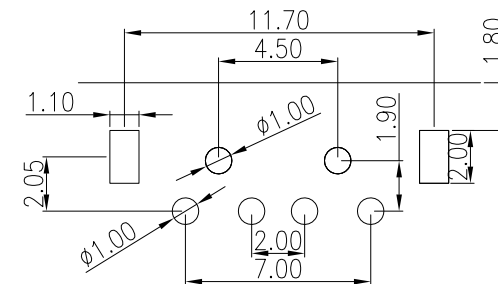


零件图	成品图	客户图
		○

REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	JIN	2020-08-28



NOTES:
 1. MATERIAL:
 HOUSING: THERMOPLASTIC UL 94-0 BLACK.
 CONTACT: COPPER ALLOY.
 SHIELD: SPCC.
 2. FINISH:
 CONTACT: GOLD PLATING ON CONTACT AREA
 MATTE-TIN PLATING ON SOLDER TAIL,
 NICKEL UNDER PLATING OVER ALL.
 SHIELD: Ni PLATING OVER ALL.
 3. ELECTRICAL:
 CONTACT RESISTANCE: 30mΩ MAX.
 WITHSTANDING VOLTAGE: 500V AC/MINUTE
 INSULATION RESISTANCE: 1000MΩ MIN



ANYCONN®
 www.anyconn.com
 TEL:+86(0)769 8904 9672
 FAX:+86(0)769 8904 9671
 E-MAIL:sales@anycom.tw

东莞市恩康电子科技有限公司

DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD

TOLERANCE ANGLE ±5° X.XXX ±0.15 X.XX ±0.25 X.X ±0.40 X. ±0.50	DATE :	2020-08-28	TITLE:			
	DRAWN :	JIN	USB2.0 A/M DIP 3.40			
	CHECKED :		PART NO: USB223			
	APPROVED :					
PROJECTON		REV: A0	UNIT: mm	SCALE: 1:1	SIZE: A4	PAGE: 1/1